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# PRESIDENCY UNIVERSITY

#### **BENGALURU**

#### **End - Term Examinations - MAY 2025**

School: SOE	Program: B. Tech				
Course Code: ECE3014	Course Name: Microcontroller Applications				
Semester: VI	Max Marks: 100	Weightage: 50%			

CO - Levels	CO1	CO2	CO3	CO4	CO5
Marks	24	24	26	26	

#### **Instructions:**

- (i) Read all questions carefully and answer accordingly.
- (ii) Do not write anything on the question paper other than roll number.

#### Part A

### Answer ALL the Questions. Each question carries 2marks.

10Q x 2M=20M

1.	State the word size for arithmetic and logical operations, and the internal bus width of 32 bit microcontroller	2 Marks	L1	CO1
2.	In 8051 microcontroller state the functions of the ALE, PSEN pins	2 Marks	L1	CO1
3.	State the operations of the XRL and ORL instructions in 8051	2 Marks	L1	CO2
4.	Find the contents of register A on execution of the following code SET C MOV A, #9BH RRC A	2 Marks	L1	CO2
5.	State the functions of each bit of the SCON register	2 Marks	L1	CO3
6.	Compute the initial value for timer in mode 1 to obtain the time delay of 12uS, given the crystal frequency is 11.0592 MHz	2 Marks	L1	<b>CO3</b>
7.	State the difference between half duplex and full duplex serial communication	2 Marks	L1	CO3
8.	What are some common applications of ARM microcontrollers in the real world?	2 Marks	L1	CO4

9.	State the three stages of pipline in instruction execution	2 Marks	L1	CO4
10.	What is the difference between ARM and Thumb instructions?	2 Marks	L1	CO4

## Part B

## Answer the Questions.

### **Total Marks 80M**

11.	a.	Compare Von Neumann architecture and Harvard architecture	10 Marks	L2	CO1
	b.	Design a μController system using 8051. Interface the external	10 Marks	L2	CO1
		RAM of size 8k x 8. Compute the address decoding map and			
		interface the memory such that starting address for RAM is			
		7000H			
		0r			
12.	a.	Explain with neat diagram the external data memory (RAM)	10 Marks	L2	CO1
		interfacing and the timing diagram of WRITE cycle.			
	b.	Examining the stack, show the contents of the register and SP	10 Marks	L2	CO1
		after execution of the following instructions.			
		MOV SP, #49H			
		MOV R3, #84H			
		MOV R5, #0BAH			
		MOV R6, #70H			
		PUSH 5			
		PUSH 6			
		POP 2			
		PUSH 3			
		POP 1			
		POP 3			

13.	a.	Determine the cont	_		-	10 Marks	L3	CO2	
		Flags after execution	on of each inst	i uction S	sequentiany.				
		Instructions	Binary value	Hex Value	Status Flags C, AC, P				
		MOV A, #9AH	A=	A=	C= AC= P=				
		MOV R2, #0A2H	R2=	R1=	C= AC= P=				
		ADD A, R2	A=	A=	C= AC= P=				
		RLC A	A=	A=	C= AC= P=				
		SWAP A	A=	A=	C= AC= P=				
		DEC R2	R2=	R1=	C= AC= P=				
		ANL A, R2	A=	A=	C= AC= P=				

		RR A	A=	A=	C=	AC=	P=			
		CPL A	A=	A=	C=	AC=	P=			
		XRL A, A	A=	A=	C=	AC=	P=			
	b.	Write an Assembly seven bytes stored stored at location 4 location 58H onwards	at memory lo 8H onwards.	cation 42	2H on	wards v	with bytes	10 Marks	L3	CO2
				0r				•		
14.	a.	Write the truth table and write an ALP to P = XY'Z + X'		xpressio		lean ex	pression	10 Marks	L3	CO2
	b.	Explain with exampted (a) JNB, (b)	oles the follow ORL, (c) SWAI	_				10 Marks	L3	<b>CO2</b>
15.	a.	2051 consist of Son	ial communic	ation Ev	nlain	the rec	ictore	10 Marks	L3	CO3
15.	a.	8051 consist of Serial communication. Explain the registers associated with Serial communication.					10 Marks	LO	CUS	
	b.	Generate a rectangular wave of 1.25kHz, with 45% duty cycle in P2.3. Assume crystal frequency as 11.0592MHz, use Timer 1 in Mode 1 operation. Show the delay calculation.						10 Marks	L3	CO3
		1		Or						
16.	a.	Write a Assembly la message "FAN" seri crystal frequency a	ially at 9600 b	aud rate	conti	nuousl	y. Assume	10 Marks	L3	CO3
	b.	8051 consist of two with timer to active	_		egistei	rs assoc	ciated	10 Marks	L3	CO3
17.	a.	Describe with neat Processor modes of	_		egiste	rs and	the	10 Marks	L3	CO4
	b.	The ARM uses the Current Program Status Register (CPSR) to monitor and control internal operations. Describe with diagram the CPSR in ARM processor						10 Marks	L3	CO4
	<u> </u>			Or				I	<u>l</u>	L
18.	a.	Explain with diagra	m the ARM co	ore data	flow n	nodel		10 Marks	L3	<b>CO4</b>
	b.	A major design rule Explain with appro RISC processor			_		_	10 Marks	L3	<b>CO4</b>